DAC0800/DAC0801/DAC0802 8-Bit Digital-to-Analog Converters

General Description

The DAC0800 series are monolithic 8-bit high-speed current-output digital-to-analog converters (DAC) featuring typical settling times of 100 ns. When used as a multiplying DAC, monotonic performance over a 40 to 1 reference current range is possible. The DAC0800 series also features high compliance complementary current outputs to allow differential output voltages of 20 Vp-p with simple resistor loads as shown in Figure~1. The reference-to-full-scale current matching of better than $\pm\,1$ LSB eliminates the need for full-scale trins in most applications while the nonlinearities of better than $\pm\,0.1\%$ over temperature minimizes system error accumulations.

The noise immune inputs of the DAC0800 series will accept TTL levels with the logic threshold pin, $V_{LC},$ grounded. Changing the V_{LC} potential will allow direct interface to other logic families. The performance and characteristics of the device are essentially unchanged over the full $\pm 4.5 V$ to $\pm 18 V$ power supply range; power dissipation is only 33 mW with $\pm 5 V$ supplies and is independent of the logic input states.

The DAC0800, DAC0802, DAC0800C, DAC0801C and DAC0802C are a direct replacement for the DAC-08, DAC-08A, DAC-08C, DAC-08E and DAC-08H, respectively.

Features

Fast settling output current
 Full scale error
 Nonlinearity over temperature
 Full scale current drift
 ± 10 ppm/°C

- High output compliance −10V to +18V
- Interface directly with TTL, CMOS, PMOS and others

■ Complementary current outputs

- 2 quadrant wide range multiplying capability
- Wide power supply range ±4.5V to ±18V
- Low power consumption 33 mW at ±5V
- Low cost

Typical Applications

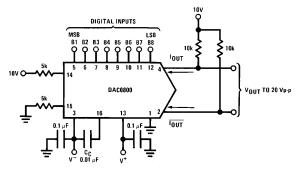


FIGURE 1. \pm 20 V_{P-P} Output Digital-to-Analog Converter (Note 4)

Ordering Information

Non-Linearity	Temperature	Order Numbers								
	Range	J Package	(J16A)*	N Package	(N16A)*	SO Package (M16A)				
±0.1% FS	$0^{\circ}\text{C} \le \text{T}_{\text{A}} \le +70^{\circ}\text{C}$	DAC0802LCJ	DAC-08HQ	DAC0802LCN	DAC-08HP	DAC0802LCM				
±0.19% FS	$-55^{\circ}\text{C} \le \text{T}_{\text{A}} \le +125^{\circ}\text{C}$	DAC0800LJ	DAC-08Q							
±0.19% FS	$0^{\circ}\text{C} \leq \text{T}_{\text{A}} \leq +70^{\circ}\text{C}$	DAC0800LCJ	DAC-08EQ	DAC0800LCN	DAC-08EP	DAC0800LCM				
±0.39% FS	$0^{\circ}C \leq T_{A} \leq +70^{\circ}C$			DAC0801LCN	DAC-08CP	DAC0801LCM				

^{*}Devices may be ordered by using either order number.

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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications. Supply Voltage ($V^+ - V^-$) $\pm\,$ 18V or 36V Power Dissipation (Note 2) 500 mW Reference Input Differential Voltage (V14 to V15) V^- to V^+ Reference Input Common-Mode Range V^- to V^+ (V14, V15) Reference Input Current 5 mA Logic Inputs V- to V- plus 36V Analog Current Outputs ($V_S^- = -15V$) ESD Susceptibility (Note 3) 4.25 mA TBD V

Storage Temperature

Lead Temp. (Soldering, 10 seconds)

Dual-In-Line Package (plastic) 260°C

Dual-In-Line Package (ceramic) 300°C

Surface Mount Package

Vapor Phase (60 seconds) 215°C

Infrared (15 seconds) 220°C

Operating Conditions (Note 1)

	Min	Max	Units
Temperature (T _A)			
DAC0800L	-55	+125	°C
DAC0800LC	0	+70	°C
DAC0801LC	0	+70	°C
DAC0802LC	0	+70	°C

Electrical Characteristics The following specifications apply for $V_S = \pm 15V$, $I_{REF} = 2$ mA and $T_{MIN} \le T_A \le T_{MAX}$ unless otherwise specified. Output characteristics refer to both I_{OUT} and $\overline{I_{OUT}}$.

 -65°C to $+150^{\circ}\text{C}$

Symbol	Parameter	Conditions	D	AC0802	LC	DAC0800L/ DAC0800LC			DAC0801LC			Units
•			Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	
	Resolution Monotonicity Nonlinearity		8 8	8	8 8 ±0.1	8 8	8	8 8 ±0.19	8 8	8	8 8 ±0.39	Bits Bits %FS
t _s	Settling Time	To $\pm \frac{1}{2}$ LSB, All Bits Switched "ON" or "OFF", T _A = 25°C DAC0800L DAC0800LC		100	135		100 100	135 150		100	150	ns ns ns
tPLH, tPHL	Propagation Delay Each Bit All Bits Switched	T _A =25°C		35 35	60 60		35 35	60 60		35 35	60 60	ns ns
TCIFS	Full Scale Tempco			±10	±50		±10	±50		±10	±80	ppm/°C
V _{OC}	Output Voltage Compliance	Full Scale Current Change <½ LSB, R _{OUT} >20 MΩ Typ	-10		18	-10		18	-10		18	٧
I _{FS4}	Full Scale Current	$V_{REF} = 10.000V, R14 = 5.000 k\Omega$ R15 = 5.000 k Ω , T _A = 25°C	1.984	1.992	2.000	1.94	1.99	2.04	1.94	1.99	2.04	mA
I _{FSS}	Full Scale Symmetry	I _{FS4} -I _{FS2}		±0.5	±4.0		±1	±8.0		±2	±16	μΑ
I _{ZS}	Zero Scale Current			0.1	1.0		0.2	2.0		0.2	4.0	μΑ
I _{FSR}	Output Current Range	$V^{-} = -5V$ $V^{-} = -8V$ to $-18V$	0	2.0 2.0	2.1 4.2	0	2.0 2.0	2.1 4.2	0	2.0 2.0	2.1 4.2	mA mA
V _{IL} V _{IH}	Logic Input Levels Logic "0" Logic "1"	V _{LC} =0V	2.0		0.8	2.0		0.8	2.0		0.8	V
I _{IL} IIH	Logic Input Current Logic "0" Logic "1"	$ \begin{array}{l} V_{LC}\!=\!0V \\ -10V\!\leq\!V_{IN}\!\leq\!+0.8V \\ 2V\!\leq\!V_{IN}\!\leq\!+18V \end{array} $		-2.0 0.002	-10 10		-2.0 0.002	-10 10		-2.0 0.002	-10 10	μΑ μΑ
V_{IS}	Logic Input Swing	V-=-15V	-10		18	-10		18	-10		18	V
V _{THR}	Logic Threshold Range	V _S = ± 15V	-10		13.5	-10		13.5	-10		13.5	V
I ₁₅	Reference Bias Current			-1.0	-3.0		-1.0	-3.0		-1.0	-3.0	μΑ
dl/dt	Reference Input Slew Rate	(Figure 12)	4.0	8.0		4.0	8.0		4.0	8.0		mA/μs
$\overline{\text{PSSI}_{\text{FS}}}_+$	Power Supply Sensitivity	4.5V≤V+≤18V		0.0001	0.01		0.0001	0.01		0.0001	0.01	%/%
PSSI _{FS} -		-4.5V≤V ⁻ ≤18V _{REF} =1mA		0.0001	0.01		0.0001	0.01		0.0001	0.01	%/%
+ -	Power Supply Current	$V_S = \pm 5V$, $I_{REF} = 1$ mA		2.3 -4.3	3.8 -5.8		2.3 -4.3	3.8 -5.8		2.3 -4.3	3.8 -5.8	mA mA
[+ [-		V _S =5V, -15V, I _{REF} =2 mA		2.4 -6.4	3.8 -7.8		2.4 -6.4	3.8 -7.8		2.4 -6.4	3.8 -7.8	mA mA
+ -		$V_S = \pm 15V$, $I_{REF} = 2 \text{ mA}$		2.5 -6.5	3.8 -7.8		2.5 -6.5	3.8 -7.8		2.5 -6.5	3.8 -7.8	mA mA

Electrical Characteristics (Continued)

The following specifications apply for $V_S=\pm 15V$, $I_{REF}=2$ mA and $I_{MIN}\leq I_{A}\leq I_{MAX}$ unless otherwise specified. Output characteristics refer to both I_{OUT} and I_{OUT} .

Symbol	Parameter	Conditions	DAC0802LC		DAC0800L/ DAC0800LC			DAC0801LC			Units	
			Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	
PD	Power Dissipation	\pm 5V, I _{REF} = 1 mA		33	48		33	48		33	48	mW
		$5V, -15V, I_{REF} = 2 \text{ mA}$		108	136		108	136		108	136	mW
		\pm 15V, I _{REF} = 2 mA		135	174		135	174		135	174	mW

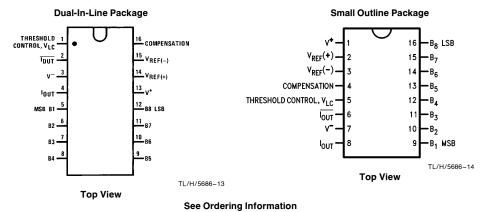
Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its specified operating conditions.

Note 2: The maximum junction temperature of the DAC0800, DAC0801 and DAC0802 is 125°C. For operating at elevated temperatures, devices in the Dual-In-Line J package must be derated based on a thermal resistance of 100°C/W, junction-to-ambient, 175°C/W for the molded Dual-In-Line N package and 100°C/W for the Small Outline M package.

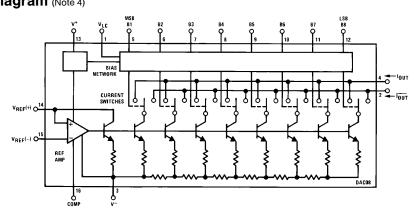
Note 3: Human body model, 100 pF discharged through a 1.5 k Ω resistor.

Note 4: Pin-out numbers for the DAC080X represent the Dual-In-Line package. The Small Outline package pin-out differs from the Dual-In-Line package.

Connection Diagrams



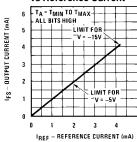
Block Diagram (Note 4)



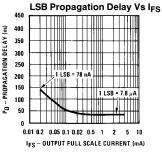
TL/H/5686-2

Typical Performance Characteristics

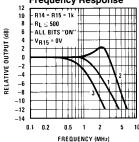
Full Scale Current vs Reference Current







Reference Input Frequency Response

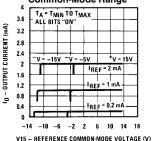


Curve 1: C_C=15 pF, V_{IN}=2 Vp-p centered at 1V.

Curve 2: $C_C = 15$ pF, $V_{IN} = 50$ mVp-p centered at 200 mV.

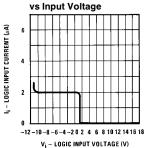
Curve 3: $C_C = 0$ pF, $V_{IN} = 100$ mVp-p at 0V and applied through 50 Ω connected to pin 14.2V applied to R14.

Reference Amp Common-Mode Range

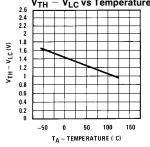


Note. Positive common-mode range is always (V+) - 1.5V

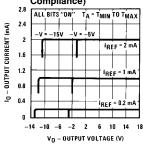
Logic Input Current



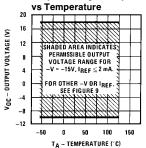
V_{LC} vs Temperature



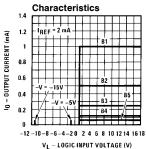
Output Current vs Output Voltage (Output Voltage Compliance)



Output Voltage Compliance



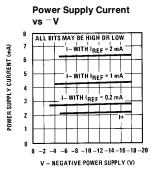
Bit Transfer

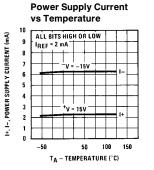


TL/H/5686-3

Note. B1-B8 have identical transfer characteristics. Bits are fully switched with less than 1/2 LSB error, at less than ± 100 mV from actual threshold. These switching points are guaranteed to lie between 0.8 and 2V over the operating temperature range ($V_{LC} = 0V$).

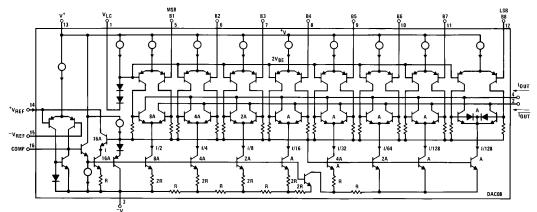
Typical Performance Characteristics (Continued)





TL/H/5686-4

Equivalent Circuit



TL/H/5686-15

Typical Applications (Continued)

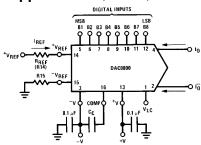


FIGURE 2

$$I_{FS} \approx \frac{+V_{REF}}{R_{REF}} \times \frac{255}{256}$$

 $I_O + \overline{I_O} = I_{FS}$ for all

logic states

For fixed reference, TTL operation,

typical values are:

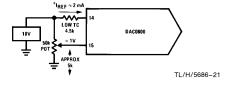
 $V_{REF} = 10.000V$

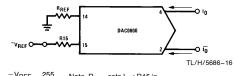
 $R_{\mathsf{REF}} = 5.000 k$

 $R15\,\approx\,R_{REF}$

 $C_C = 0.01 \mu F$ $V_{LC} = 0V \text{ (Ground)}$

TL/H/5686-5 FIGURE 3. Basic Positive Reference Operation (Note 4)



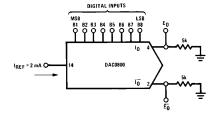


 $I_{FS} \approx \frac{-V_{REF}}{R_{RFF}} \times \frac{255}{256} \qquad \begin{array}{l} \text{Note. R}_{REF} \text{ sets I}_{FS}; R15 \text{ is} \\ \text{for bias current cancellation} \end{array}$

FIGURE 4. Recommended Full Scale Adjustment Circuit (Note 4)

FIGURE 5. Basic Negative Reference Operation (Note 4)

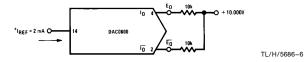
Typical Applications (Continued)



TL/H/5686-17

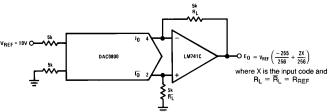
B1 B2 B3 B4 B5 B6 B7 B8 I_O mA I_O mA Εo Eo 0.000 Full Scale 1.992 0.000 -9.960 $\mathsf{Full} \; \mathsf{Scale} \! - \! \mathsf{LSB}$ -9.9200 1.984 0.008 -0.040 ${\sf Half\,Scale} + {\sf LSB}$ 0 0 0 0 0 0 1.008 0.984 -5.0404.920 -5.000 -4.960 Half Scale 0 0 0 0 1.000 0.992 $\mathsf{Half}\,\mathsf{Scale}\!-\!\mathsf{LSB}$ 0.992 1.000 -4.960-5.000 ${\sf Zero\ Scale} + {\sf LSB}$ 0 0 0 0 0 0 0 0.008 1.984 -0.040-9.920Zero Scale 0 0.000 1.992 0.000 -9.960

FIGURE 6. Basic Unipolar Negative Operation (Note 4)



	В1	B2	В3	В4	В5	В6	В7	В8	Eo	ΕO
Pos. Full Scale	1	1	1	1	1	1	1	1	-9.920	+10.000
Pos. Full Scale – LSB	1	1	1	1	1	1	1	0	-9.840	+ 9.920
Zero Scale + LSB	1	0	0	0	0	0	0	1	-0.080	+0.160
Zero Scale	1	0	0	0	0	0	0	0	0.000	+0.080
Zero Scale – LSB	0	1	1	1	1	1	1	1	+0.080	0.000
Neg. Full Scale + LSB	0	0	0	0	0	0	0	1	+9.920	-9.840
Neg. Full Scale	0	0	0	0	0	0	0	0	+10.000	-9.920

FIGURE 7. Basic Bipolar Output Operation (Note 4)

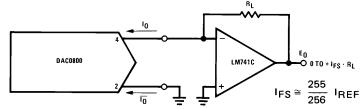


 $\label{eq:TL/H/5686-18} \Xi$ TL/H/5686-18 If $R_L=\overline{R_L}$ within $\pm 0.05\%$, output is symmetrical about ground

B1 B2 B3 B4 B5 B6 B7 B8 Pos. Full Scale +9.960Pos. Full Scale-LSB +9.880(+)Zero Scale 0 0 0 0 0 +0.0400 0 (-)Zero Scale -0.0400 1 1 1 1 1 Neg. Full Scale + LSB 0 0 0 0 0 0 0 -9.880Neg. Full Scale 0 0 0 0 0 0 -9.9600

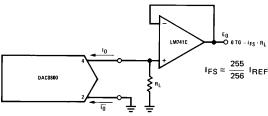
FIGURE 8. Symmetrical Offset Binary Operation (Note 4)

Typical Applications (Continued)



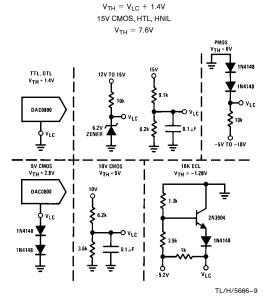
For complementary output (operation as negative logic DAC), connect inverting input of op amp to $\overline{l_0}$ (pin 2), connect l_0 (pin 4) to ground.

FIGURE 9. Positive Low Impedance Output Operation (Note 4)



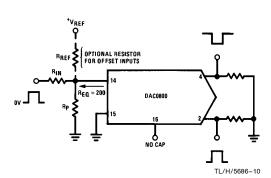
For complementary output (operation as a negative logic DAC) connect non-inverting input of op am to $\overline{l_0}$ (pin 2); connect l_0 (pin 4) to ground.

FIGURE 10. Negative Low Impedance Output Operation (Note 4)



Note. Do not exceed negative logic input range of DAC.

FIGURE 11. Interfacing with Various Logic Families



TL/H/5686-19

TL/H/5686-20

Typical values: $R_{IN} = 5k$, $+V_{IN} = 10V$

FIGURE 12. Pulsed Reference Operation (Note 4)

Typical Applications (Continued) (a) $I_{\mbox{\scriptsize REF}} \geq$ peak negative swing of $I_{\mbox{\scriptsize IN}}$ (b) $\,^+\text{V}_{\text{REF}}$ must be above peak positive swing of V_{IN} IREF DAC0800 R15 (OPTIONAL) DAC0800 TL/H/5686-12 TL/H/5686-11 FIGURE 13. Accommodating Bipolar References (Note 4) MINIMUM CAPACITANCE HP5082-2800 SCHOTTKY DIODES 100k OUT DAC0800 (D.U.T.) -15V TO D.U.T. 0.01 µF TL/H/5686-7 FIGURE 14. Settling Time Measurement (Note 4)

Typical Applications (Continued)

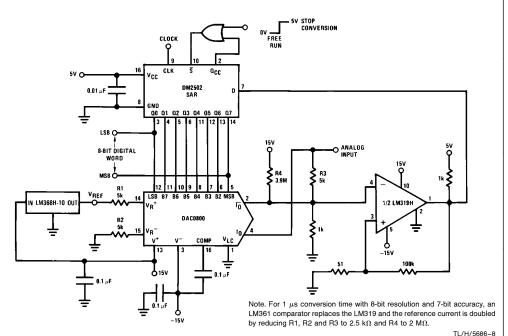
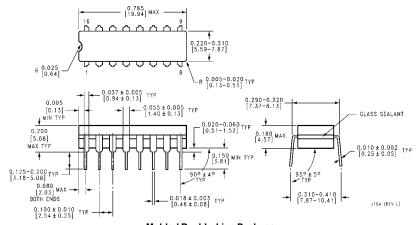


FIGURE 15. A Complete 2 μ s Conversion Time, 8-Bit A/D Converter (Note 4)

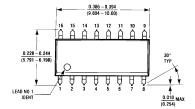
Physical Dimensions inches (millimeters)

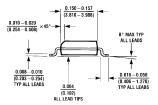


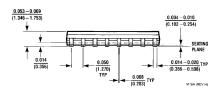
Molded Dual-In-Line Package Order Numbers DAC0800 or DAC0802 NS Package Number J16A

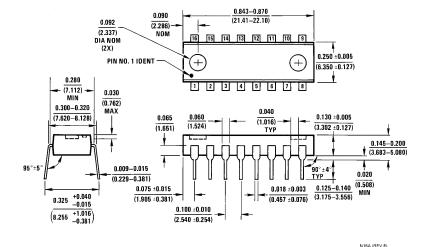
Physical Dimensions inches (millimeters) (Continued)

Molded Small Outline Package (SO) Order Numbers DAC0800LCM, DAC0801LCM or DAC0802LCM NS Package Number M16A









Molded Dual-In-Line Package Order Numbers DAC0800, DAC0801, DAC0802 NS Package Number N16A

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